

# ADC121S625

## 12-Bit, 50 ksp/s to 200 ksp/s, Differential Input, Micro Power Sampling A/D Converter

### General Description

The ADC121S625 is a 12-bit, 50 ksp/s to 200 ksp/s sampling Analog-to-Digital (A/D) converter that features a fully differential, high impedance analog input and an external reference. While best performance is achieved with reference voltage between 500mV and 2.5V, the reference voltage can be varied from 100mV to 2.5V, with a corresponding resolution between 49µV and 1.22mV.

The output serial data is binary 2's complement, and is compatible with several standards, such as SPI™, QSPI™, MICROWIRE™, and with many common DSP serial interfaces. The differential input, low power, automatic power down, and small size make the ADC121S625 ideal for direct connection to transducers in battery operated systems or remote data acquisition applications.

Operating from a single +5V supply, the normal power consumption is reduced to a few nanowatts in the power-down mode. The ADC121S625 is a pin-compatible superior replacement for the ADS7817 and is available in the MSOP-8 package. Operation is guaranteed over the industrial temperature range of -40°C to +85°C and clock rates of 800 kHz to 3.2 MHz.

### Features

- True Differential Inputs
- Guaranteed performance from 50ksp/s to 200ksp/s
- External Reference
- High AC Common-Mode Rejection
- SPI™/QSPI™/MICROWIRE™/DSP compatible Serial Interface

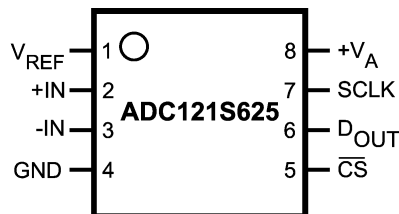
### Key Specifications

|                     |                  |
|---------------------|------------------|
| ■ Conversion Rate   | 50 to 200 ksp/s  |
| ■ Offset Error      | 0.4 LSB (typ)    |
| ■ Gain Error        | 0.05 LSB (typ)   |
| ■ INL               | ± 1 LSB (max)    |
| ■ DNL               | ± 0.75 LSB (max) |
| ■ CMRR              | 82 dB (typ)      |
| ■ Power Consumption |                  |
| — Active, 200ksp/s  | 2.25 mW (typ)    |
| — Active, 50ksp/s   | 1.33 mW (typ)    |
| — Power Down        | 60 nW (typ)      |

### Applications

- Automotive Navigation
- Portable Systems
- Medical Instruments
- Instrumentation and Control Systems
- Motor Control
- Direct Sensor Interface

### Connection Diagram

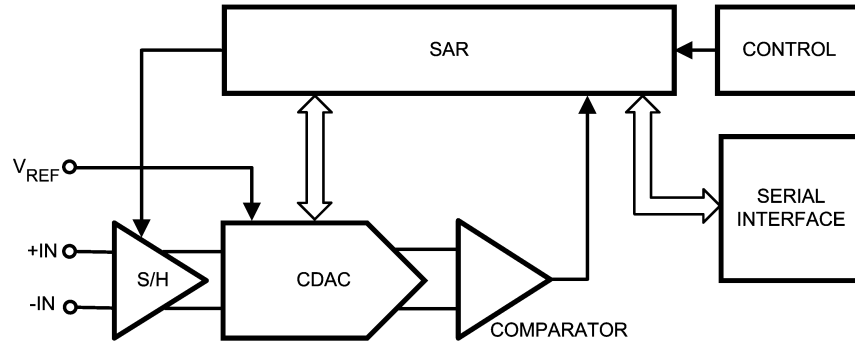


### Ordering Information

| Order Code      | Temperature Range | Description                                 | Top Mark |
|-----------------|-------------------|---|----------|
| ADC121S625C1MM  | -40°C to +85°C    | 8-Lead MSOP Package, 1000 Units Tape & Reel | X0AC     |
| ADC121S625C1MMX | -40°C to +85°C    | 8-Lead MSOP Package, 3500 Units Tape & Reel | X0AC     |
| ADC121S625EVAL  |                   | Evaluation Board                            |          |

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## Block Diagram



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## Pin Descriptions and Equivalent Circuits

| Pin No. | Symbol          | Description   |
|---------|-----------------|---|
| 1       | $V_{REF}$       | Reference Voltage input.  |
| 2       | +IN             | Non-inverting input.  |
| 3       | -IN             | Inverting input.  |
| 4       | GND             | Ground pin.   |
| 5       | $\overline{CS}$ | The ADC is in the active mode when this pin is LOW and in the Power-Down Mode when this pin is HIGH. A conversion begins at the fall of $\overline{CS}$ .   |
| 6       | $D_{OUT}$       | The serial output data word is comprised of 12 bits of data. In operation the data is valid on the falling edge of SCLK. The second clock pulse after the falling edge of $\overline{CS}$ enables the serial output. After one null bit the data is valid for the next 12 SCLK edges. |
| 7       | SCLK            | Serial Clock used to control data transfer. Also serves as the conversion clock.  |
| 8       | $V_A$           | Power Supply input.   |

### Absolute Maximum Ratings (Notes 1, 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

|   |                           |
|---|---------------------------|
| Analog Supply Voltage $V_A$                   | -0.3V to 6.5V             |
| Voltage on Any Pin to GND                     | -0.3V to ( $V_A + 0.3V$ ) |
| Input Current at Any Pin (Note 3)             | $\pm 10$ mA               |
| Package Input Current (Note 3)                | $\pm 50$ mA               |
| Power Consumption at $T_A = 25^\circ\text{C}$ | See (Note 4)              |
| ESD Susceptibility (Note 5)                   |                           |
| Human Body Model                              | 2500V                     |
| Machine Model                                 | 250V                      |
| Charge Device Modeling (CDM)                  | 750V                      |
| Soldering Temperature, Infrared,              |                           |
| 10 seconds (Note 6)                           | 260°C                     |
| Junction Temperature                          | +150°C                    |
| Storage Temperature                           | -65°C to +150°C           |

### Operating Ratings (Notes 1, 2)

|                                     |   |
|-------------------------------------|---|
| Operating Temperature Range         | $-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$ |
| Supply Voltage, $V_A$               | +4.5V to +5.5V                                      |
| Reference Voltage, $V_{REF}$        | +0.1V to 2.5V                                       |
| Input Common-Mode Voltage, $V_{CM}$ | See Figure 1 (Sect 2.3)                             |
| Digital Input Pins Voltage Range    | 0 to $V_A$  |
| Clock Frequency                     | 0.8 MHz to 3.2 MHz                                  |
| Differential Analog Input Voltage   | $-V_{REF}$ to $+V_{REF}$                            |

### Package Thermal Resistance

| Package     | $\theta_{JA}$ |
|-------------|---------------|
| 8-lead MSOP | 20°C / W      |

### ADC121S625 Converter Electrical Characteristics (Note 8)

The following specifications apply for  $V_A = +4.5V$  to 5.5V,  $V_{REF} = 2.5V$ ,  $f_{SCLK} = 0.8$  to 3.2 MHz,  $f_{IN} = 20$  kHz,  $C_L = 100$  pF, unless otherwise noted. **Boldface limits apply for  $T_A = T_{MIN}$  to  $T_{MAX}$** ; all other limits  $T_A = 25^\circ\text{C}$ .

| Symbol                                   | Parameter                             | Conditions                      | Typical            | Limits                       | Units (Note 7)         |
|--|---------------------------------------|---------------------------------|--------------------|------------------------------|------------------------|
| <b>STATIC CONVERTER CHARACTERISTICS</b>  |                                       |                                 |                    |                              |                        |
|  | Resolution with No Missing Codes      |                                 |                    | <b>12</b>                    | Bits                   |
| INL                                      | Integral Non-Linearity                |                                 | +0.5<br>-0.3       | <b>+1.0</b><br><b>-1.0</b>   | LSB (max)<br>LSB (min) |
| DNL                                      | Differential Non-Linearity            |                                 | $\pm 0.4$          | <b><math>\pm 0.75</math></b> | LSB (max)              |
| OE                                       | Offset Error                          |                                 | 0.4                | <b><math>\pm 4</math></b>    | LSB (max)              |
| FSE                                      | Positive Full-Scale Error             |                                 | +0.2               |                              | LSB                    |
|  | Negative Full-Scale Error             |                                 | +0.2               |                              | LSB                    |
| GE                                       | Gain Error                            |                                 | -0.05              | <b><math>\pm 4</math></b>    | LSB                    |
| <b>DYNAMIC CONVERTER CHARACTERISTICS</b> |                                       |                                 |                    |                              |                        |
| SINAD                                    | Signal-to-Noise Plus Distortion Ratio | $f_{IN} = 20$ kHz, -0.1 dBFS    | 72.6               | <b>68.5</b>                  | dBc (min)              |
| SNR                                      | Signal-to-Noise Ratio                 | $f_{IN} = 20$ kHz, -0.1 dBFS    | 72.9               | <b>70</b>                    | dBc (min)              |
| THD                                      | Total Harmonic Distortion             | $f_{IN} = 20$ kHz, -0.1 dBFS    | -84                | <b>-74</b>                   | dBc (max)              |
| SFDR                                     | Spurious-Free Dynamic Range           | $f_{IN} = 20$ kHz, -0.1 dBFS    | 85.2               | <b>74</b>                    | dBc (min)              |
| ENOB                                     | Effective Number of Bits              | $f_{IN} = 20$ kHz, -0.1 dBFS    | 11.8               | <b>11.1</b>                  | bits (min)             |
| FPBW                                     | -3 dB Full Power Bandwidth            | Output at 70.7%FS with FS Input | Differential Input | 26                           | MHz                    |
|  |                                       | Single-Ended Input              | 22                 | MHz                          |                        |
| <b>ANALOG INPUT CHARACTERISTICS</b>      |                                       |                                 |                    |                              |                        |
| $V_{IN}$                                 | Differential Input Range              |                                 |                    | $-V_{REF}$                   | V (min)                |
|  |                                       |                                 |                    | $+V_{REF}$                   | V (max)                |
| $I_{DCL}$                                | DC Leakage Current                    |                                 | $\pm 0.04$         | <b><math>\pm 2</math></b>    | $\mu\text{A}$ (max)    |
| $C_{INA}$                                | Input Capacitance                     | In Track Mode                   | 17                 |                              | pF                     |
|  |                                       | In Hold Mode                    | 3                  |                              | pF                     |
| CMRR                                     | Common Mode Rejection Ratio           |                                 | 82                 |                              | dB                     |
| $V_{REF}$                                | Reference Voltage Range               |                                 |                    | <b>0.1</b>                   | V (min)                |
|  |                                       |                                 |                    | <b>2.5</b>                   | V (max)                |

## ADC121S625 Converter Electrical Characteristics (Note 8) (Continued)

The following specifications apply for  $V_A = +4.5V$  to  $5.5V$ ,  $V_{REF} = 2.5V$ ,  $f_{SCLK} = 0.8$  to  $3.2$  MHz,  $f_{IN} = 20$  kHz,  $C_L = 100$  pF, unless otherwise noted. **Boldface limits apply for  $T_A = T_{MIN}$  to  $T_{MAX}$** ; all other limits  $T_A = 25^\circ C$ .

| Symbol                                | Parameter  | Conditions  | Typical               | Limits                        | Units<br>(Note 7) |
|---------------------------------------|--|---|-----------------------|-------------------------------|-------------------|
| <b>ANALOG INPUT CHARACTERISTICS</b>   |  |   |                       |                               |                   |
| $I_{REF}$                             | Reference Current                                      | $\overline{CS}$ low, $f_{SCLK} = 3.2$ MHz,<br>$f_S = 200$ ksps, output = FF8h                     | 12                    |                               | $\mu A$           |
|                                       |  | $\overline{CS}$ low, $f_{SCLK} = 3.2$ MHz,<br>$f_S = 50$ ksps, output = FF8h                      | 3                     |                               | $\mu A$           |
|                                       |  | $\overline{CS}$ low, $f_{SCLK} = 3.2$ MHz,<br>12.5 ksps, output = FF8h                            | 0.7                   |                               | $\mu A$           |
|                                       |  | $\overline{CS}$ high, $f_{SCLK} = 0$  | 0.3                   |                               | $\mu A$           |
| <b>DIGITAL INPUT CHARACTERISTICS</b>  |  |   |                       |                               |                   |
| $V_{IH}$                              | Input High Voltage                                     | $V_A = 4.5V$ to $5.5V$  |                       | <b>2.4</b>                    | V (min)           |
| $V_{IL}$                              | Input Low Voltage                                      | $V_A = 4.5V$ to $5.5V$  |                       | <b>0.8</b>                    | V (max)           |
| $I_{IN}$                              | Input Current  | $V_{IN} = 0V$ or $V_A$  | $\pm 0.03$            | <b>1</b>                      | $\mu A$ (max)     |
| $C_{IND}$                             | Input Capacitance                                      |   | 2                     | <b>4</b>                      | pF (max)          |
| <b>DIGITAL OUTPUT CHARACTERISTICS</b> |  |   |                       |                               |                   |
| $V_{OH}$                              | Output High Voltage                                    | $V_A = 4.5V$ to $5.5V$ , $I_{SOURCE} = 250 \mu A$   | $V_A - 0.05$          | <b><math>V_A - 0.2</math></b> | V (min)           |
|                                       |  | $V_A = 4.5V$ to $5.5V$ , $I_{SOURCE} = 2$ mA  | $V_A - 0.1$           |                               | V                 |
| $V_{OL}$                              | Output Low Voltage                                     | $V_A = 4.5V$ to $5.5V$ , $I_{SINK} = 250 \mu A$   | 0.02                  | <b>0.4</b>                    | V (max)           |
|                                       |  | $V_A = 4.5V$ to $5.5V$ , $I_{SOURCE} = 2$ mA  | 0.1                   |                               | V                 |
| $I_{OZH}$ ,<br>$I_{OZL}$              | TRI-STATE Leakage Current                              |   | $\pm 0.03$            | <b><math>\pm 1</math></b>     | $\mu A$ (max)     |
| $C_{OUT}$                             | TRI-STATE Output Capacitance                           |   | 2                     | <b>4</b>                      | pF (max)          |
|                                       | Output Coding  |   | Binary 2'S Complement |                               |                   |
| <b>POWER SUPPLY CHARACTERISTICS</b>   |  |   |                       |                               |                   |
| $V_A$                                 | Analog Supply Voltage                                  |   |                       | <b>4.5</b>                    | V (min)           |
|                                       |  |   |                       | <b>5.5</b>                    | V (max)           |
| $I_A$ Active                          | Supply Current, Normal Mode<br>(Operational)           | $f_{SCLK} = 3.2$ MHz, $f_{SMPL} = 200$ ksps,<br>$f_{IN} = 20$ kHz, $C_L = 15pF$                   | 410                   | <b>510</b>                    | $\mu A$ (max)     |
|                                       |  | $f_{SCLK} = 3.2$ MHz, $f_{SMPL} = 12.5$ ksps,<br>$C_L = 15pF$ , Power Down between<br>conversions | 31                    |                               | $\mu A$           |
|                                       |  | $f_{SCLK} = 0.8$ MHz, $f_{SMPL} = 50$ ksps,<br>$C_L = 15pF$                                       | 242                   |                               | $\mu A$           |
|                                       |  | $f_{SCLK} = 0.2$ MHz, $f_{SMPL} = 12.5$ ksps,<br>$C_L = 15pF$ (Note 10)                           | 200                   |                               | $\mu A$           |
| $I_A$<br>Shutdown                     | Supply Current, Shutdown ( $\overline{CS}$ high)       | $f_{SCLK} = 0$  | 0.01                  | <b>2</b>                      | $\mu A$ (max)     |
|                                       |  | $f_{SCLK} = 3.2$ MHz  | 6                     |                               | $\mu A$           |
| PWR<br>Active                         | Power Consumption, Normal Mode<br>(Operational)        | $f_{SCLK} = 3.2$ MHz, $f_{SMPL} = 200$ ksps,<br>$f_{IN} = 20$ kHz, $C_L = 15pF$                   | 2.25                  | <b>2.8</b>                    | mW (max)          |
|                                       |  | $f_{SCLK} = 3.2$ MHz, $f_{SMPL} = 12.5$ ksps,<br>$C_L = 15pF$ , Power Down between<br>conversions | 0.18                  |                               | mW                |
|                                       |  | $f_{SCLK} = 0.8$ MHz, $f_{SMPL} = 50$ ksps,<br>$C_L = 15pF$                                       | 1.33                  |                               | mW                |
|                                       |  | $f_{SCLK} = 0.2$ MHz, $f_{SMPL} = 12.5$ ksps,<br>$C_L = 15pF$ (Note 10)                           | 1.1                   |                               | mW                |
| PWR<br>Shutdown                       | Power Consumption, Shutdown ( $\overline{CS}$<br>high) | $f_{SCLK} = 0$  | 0.06                  | <b>11</b>                     | $\mu W$ (max)     |
|                                       |  | $f_{SCLK} = 3.2$ MHz  | 33                    |                               | $\mu W$           |

**ADC121S625 Converter Electrical Characteristics** (Note 8) (Continued)

The following specifications apply for  $V_A = +4.5V$  to  $5.5V$ ,  $V_{REF} = 2.5V$ ,  $f_{SCLK} = 0.8$  to  $3.2$  MHz,  $f_{IN} = 20$  kHz,  $C_L = 100$  pF, unless otherwise noted. **Boldface limits apply for  $T_A = T_{MIN}$  to  $T_{MAX}$** ; all other limits  $T_A = 25^\circ C$ .

| Symbol                               | Parameter                    | Conditions                                  | Typical | Limits     | Units<br>(Note 7) |
|--------------------------------------|------------------------------|---|---------|------------|-------------------|
| <b>POWER SUPPLY CHARACTERISTICS</b>  |                              |   |         |            |                   |
| PSRR                                 | Power Supply Rejection Ratio | Offset Change with 1.0V change in $V_A$     | 71      |            | dB                |
|                                      |                              | Gain Error Change with 1.0V change in $V_A$ | 83      |            | dB                |
| <b>AC ELECTRICAL CHARACTERISTICS</b> |                              |   |         |            |                   |
| $f_{SCLK}$                           | Maximum Clock Frequency      |   | 4.8     | <b>3.2</b> | MHz (min)         |
| $f_{SCLK}$                           | Minimum Clock Frequency      |   | 200     | <b>800</b> | kHz (max)         |
| $f_s$                                | Maximum Sample Rate          |   | 300     | <b>200</b> | ksps (min)        |
| $t_{ACQ}$                            | Track/Hold Acquisition Time  |   |         | <b>1.5</b> | SCLK cycles (min) |
|                                      |                              |   |         | <b>2.0</b> | SCLK cycles (max) |
| $t_{CONV}$                           | Conversion Time              |   | 12      | <b>12</b>  | SCLK cycles       |
| $t_{CYC}$                            | Throughput Time              | Normal Operation                            |         | <b>16</b>  | SCLK cycles       |
|                                      |                              | Short Cycled                                |         | <b>14</b>  | SCLK cycles (min) |
| $f_{RATE}$                           | Throughput Rate              |   |         | <b>200</b> | ksps (max)        |
| $t_{AD}$                             | Aperture Delay               |   | 6       |            | ns                |

**ADC121S625 Timing Specifications** (Note 8)

The following specifications apply for  $V_A = +4.5V$  to  $5.5V$ ,  $V_{REF} = 2.5V$ ,  $f_{SCLK} = 0.8$  MHz to  $3.2$  MHz,  $C_L = 100$  pF, **Boldface limits apply for  $T_A = T_{MIN}$  to  $T_{MAX}$** ; all other limits  $T_A = 25^\circ C$ .

| Symbol     | Parameter   | Conditions | Typical | Limits     | Units    |
|------------|---|------------|---------|------------|----------|
| $t_{CFCS}$ | SCLK Fall to $\overline{CS}$ Fall                             |            |         | <b>0</b>   | ns (min) |
| $t_{CSCR}$ | $\overline{CS}$ Fall to SCLK Rise                             | (Note 9)   |         | <b>0</b>   | ns (min) |
| $t_{CHLD}$ | SCLK Fall to Data Change Hold Time                            | (Note 9)   |         | <b>10</b>  | ns (min) |
| $t_{CDV}$  | SCLK Fall to Next $D_{OUT}$ Valid                             |            | 38      | <b>100</b> | ns (max) |
| $t_{DIS}$  | Rising Edge of $\overline{CS}$ To $D_{OUT}$ Disabled          |            | 38      | <b>50</b>  | ns (max) |
| $t_{EN}$   | 2nd SCLK Fall after $\overline{CS}$ Fall to $D_{OUT}$ Enabled |            | 6       | <b>50</b>  | ns (max) |
| $t_{CH}$   | SCLK High Time  |            | 42      | <b>60</b>  | ns (min) |
| $t_{CL}$   | SCLK Low Time   |            | 42      | <b>60</b>  | ns (min) |
| $t_r$      | $D_{OUT}$ Rise Time   |            | 5       | <b>50</b>  | ns (max) |
| $t_f$      | $D_{OUT}$ Fall Time   |            | 13      | <b>50</b>  | ns (max) |

**Note 1:** Absolute maximum ratings are limiting values which indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

**Note 2:** All voltages are measured with respect to GND = 0V, unless otherwise specified.

**Note 3:** When the input voltage at any pin exceeds the power supplies (that is,  $V_{IN} < AGND$  or  $V_{IN} > V_A$  or  $V_D$ ), the current at that pin should be limited to 10 mA. The 50 mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 10 mA to five.

**Note 4:** The absolute maximum junction temperature ( $T_{Jmax}$ ) for this device is  $150^\circ C$ . The maximum allowable power dissipation is dictated by  $T_{Jmax}$ , the junction-to-ambient thermal resistance ( $\theta_{JA}$ ), and the ambient temperature ( $T_A$ ), and can be calculated using the formula  $P_{DMAX} = (T_{Jmax} - T_A)/\theta_{JA}$ . The values for maximum power dissipation listed above will be reached only when the ADC121S625 is operated in a severe fault condition (e.g. when input or output pins are driven beyond the power supply voltages, or the power supply polarity is reversed). Obviously, such conditions should always be avoided.

**Note 5:** Human body model is 100 pF capacitor discharged through a 1.5 k $\Omega$  resistor. Machine model is 220 pF discharged through ZERO ohms.

**Note 6:** See AN450, "Surface Mounting Methods and Their Effect on Product Reliability", or the section entitled "Surface Mount" found in any post 1986 National Semiconductor Linear Data Book, for other methods of soldering surface mount devices.

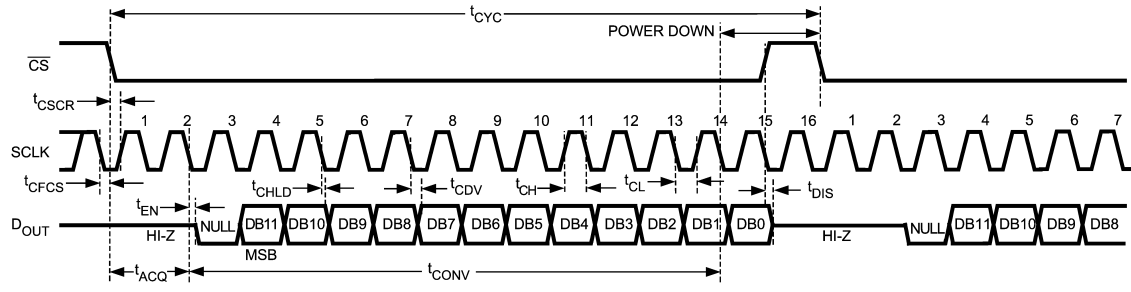
**Note 7:** Tested limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

**Note 8:** Data sheet min/max specification limits are guaranteed by design, test, or statistical analysis.

**Note 9:** Clock should be in low when  $\overline{CS}$  is asserted, as indicated by the  $t_{CSCR}$  and  $t_{CFCS}$  specifications.

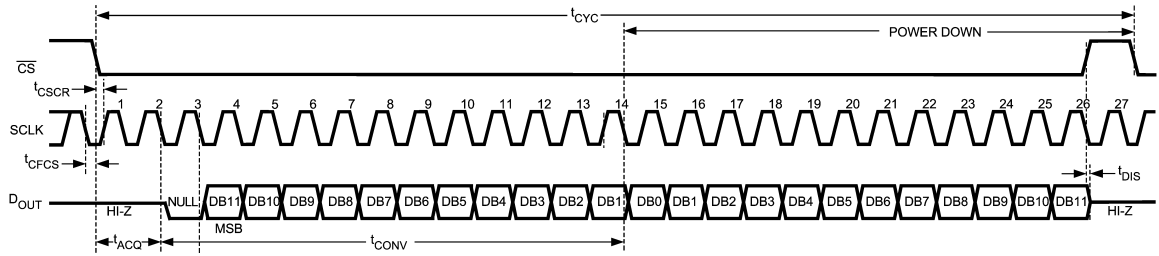
**Note 10:** While the maximum sample rate is  $f_{SCLK}/16$ , the actual sample rate may be lower than this by having the  $\overline{CS}$  rate being slower than  $f_{SCLK}/16$ .

# Timing Diagrams



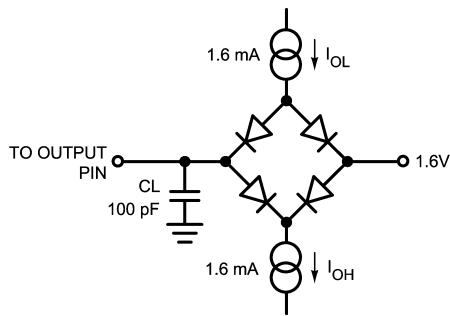
ADC121S625 Single Cycle Timing Diagram

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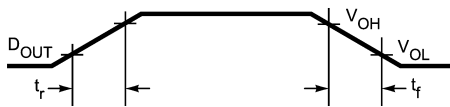
ADC121S625 Double Cycle Timing Diagram

20132704



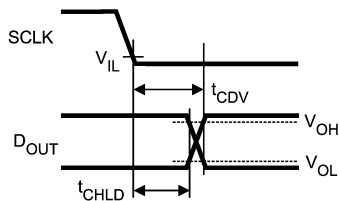
Timing Test Circuit

20132708



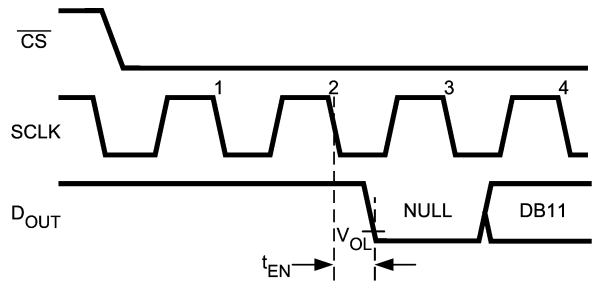
Voltage Waveform for  $D_{OUT}$ ,  $t_r$ ,  $t_f$

20132706



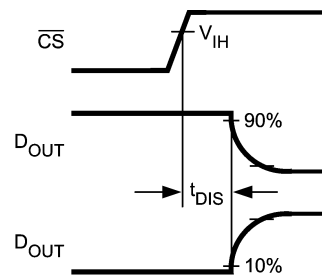
Voltage Waveforms for  $d_{OUT}$  delay time,  $t_{CDV}$

20132711



Voltage Waveform for  $t_{EN}$

20132710



Voltage Waveform for  $t_{DIS}$

20132712

## Specification Definitions

**APERTURE DELAY** is the time between the second falling SCLK edge of a conversion and the time when the input signal is acquired or held for conversion.

**COMMON MODE REJECTION RATIO (CMRR)** is a measure of how well in-phase signals common to both input pins are rejected.

$$\text{CMRR} = 20 \text{ LOG } (\Delta\text{Common Input} / \Delta\text{Output})$$

**CONVERSION TIME** is the time required, after the input voltage is acquired, for the ADC to convert the input voltage to a digital word.

**DIFFERENTIAL NON-LINEARITY (DNL)** is the measure of the maximum deviation from the ideal step size of 1 LSB.

**DUTY CYCLE** is the ratio of the time that a repetitive digital waveform is high to the total time of one period. The specification here refers to the SCLK.

**EFFECTIVE NUMBER OF BITS (ENOB, or EFFECTIVE BITS)** is another method of specifying Signal-to-Noise and Distortion or SINAD. ENOB is defined as  $(\text{SINAD} - 1.76) / 6.02$  and says that the converter is equivalent to a perfect ADC of this (ENOB) number of bits.

**FULL POWER BANDWIDTH** is a measure of the frequency at which the reconstructed output fundamental drops 3 dB below its low frequency value for a full scale input.

**GAIN ERROR** is the difference between Positive Full Scale Error and Negative Full Scale Error.

**INTEGRAL NON-LINEARITY (INL)** is a measure of the deviation of each individual code from a line drawn from negative full scale ( $1/2$  LSB below the first code transition) through positive full scale ( $1/2$  LSB above the last code transition). The deviation of any given code from this straight line is measured from the center of that code value.

**MISSING CODES** are those output codes that will never appear at the ADC outputs. The ADC121S625 is guaranteed not to have any missing codes.

**NEGATIVE FULL-SCALE ERROR** is the difference between the differential input voltage at which the output code transitions from negative full scale and the next code and  $-V_{\text{REF}} + 0.5 \text{ LSB}$

**OFFSET ERROR** is the difference between the differential input voltage at which the output code transitions from code 000h to 001h and  $1/2 \text{ LSB}$ .

**POSITIVE FULL-SCALE ERROR** is the difference between the differential input voltage at which the output code transitions to positive full scale  $V_{\text{REF}}$  minus  $1.5 \text{ LSB}$ .

**POWER SUPPLY REJECTION RATIO (PSRR)** is a measure of how well a change in the supply voltage is rejected. It is the ratio of the change in Full-Scale Gain Error or the Offset Error that results from a change in the d.c. power supply voltage, expressed in dB.

$$\text{PSRR} = 20 \text{ LOG } (\Delta V_A / \Delta\text{Offset})$$

$$\text{PSRR} = 20 \text{ LOG } (\Delta V_A / \Delta\text{Gain})$$

**SIGNAL TO NOISE RATIO (SNR)** is the ratio, expressed in dB, of the rms value of the input signal to the rms value of the sum of all other spectral components below one-half the sampling frequency, not including harmonics or d.c.

**SIGNAL TO NOISE PLUS DISTORTION (S/N+D or SINAD)** is the ratio, expressed in dB, of the rms value of the input signal to the rms value of all of the other spectral components below half the clock frequency, including harmonics but excluding d.c.

**SPURIOUS FREE DYNAMIC RANGE (SFDR)** is the difference, expressed in dB, between the rms values of the input signal and the peak spurious signal, where a spurious signal is any signal present in the output spectrum that is not present at the input.

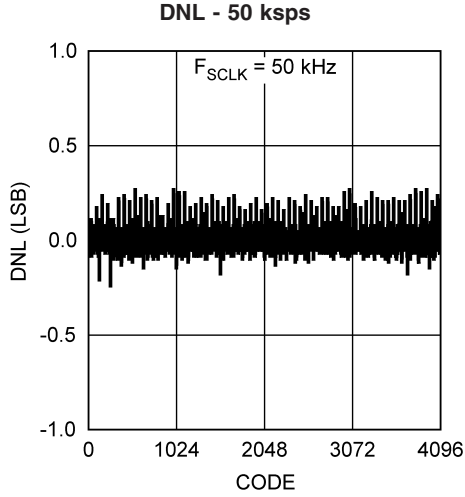
**TOTAL HARMONIC DISTORTION (THD)** is the ratio, expressed in dB, expressed in dB or dBc, of the rms total of the first five harmonic components at the output to the rms level of the input signal frequency as seen at the output. THD is calculated as

$$\text{THD} = 20 \cdot \log_{10} \sqrt{\frac{A_{f2}^2 + \dots + A_{f6}^2}{A_{f1}^2}}$$

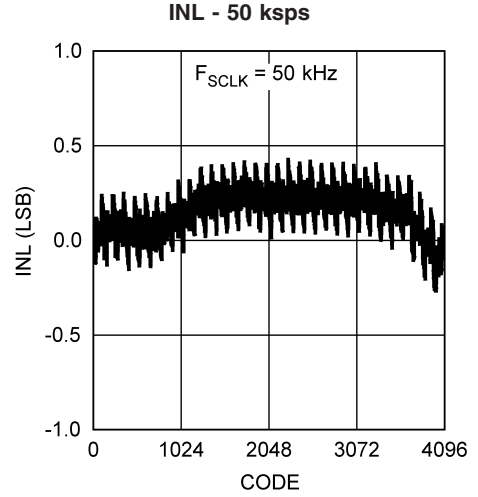
where  $A_{f1}$  is the RMS power of the input frequency at the output and  $A_{f2}$  through  $A_{f10}$  are the RMS power in the first 9 harmonic frequencies.

**THROUGHPUT TIME** is the minimum time required between the start of two successive conversions.

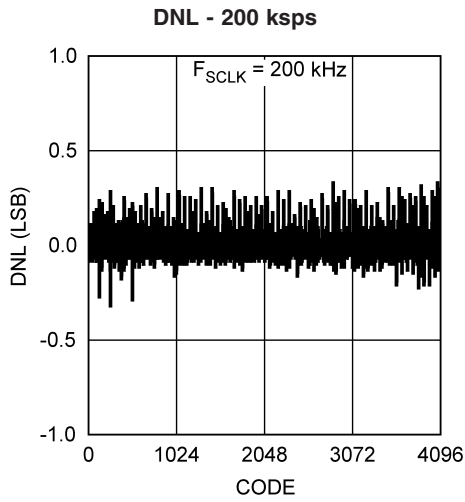
**Typical Performance Characteristics**  $T_A = +25^\circ\text{C}$ ,  $f_{\text{SAMPLE}} = 200 \text{ kpsps}$ ,  $f_{\text{SCLK}} = 3.2 \text{ MHz}$ ,  $f_{\text{IN}} = 20 \text{ kHz}$  unless otherwise stated.



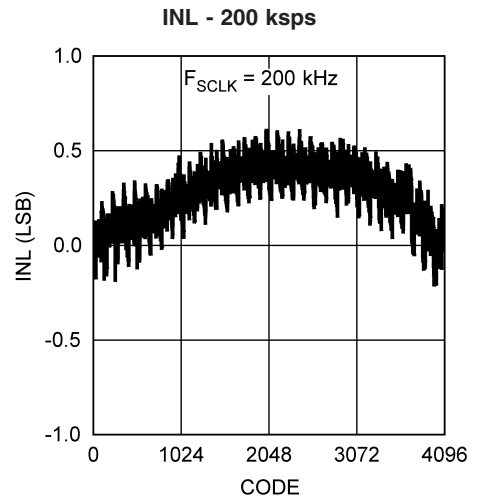
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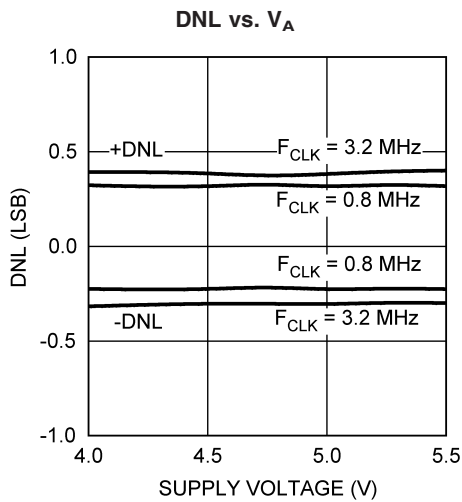
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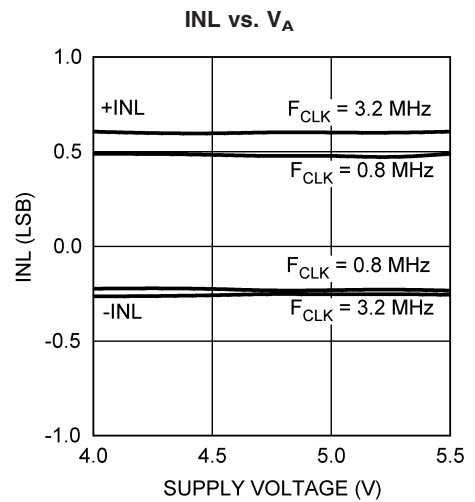
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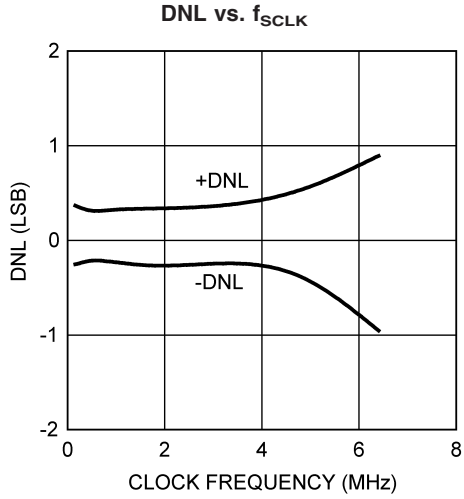
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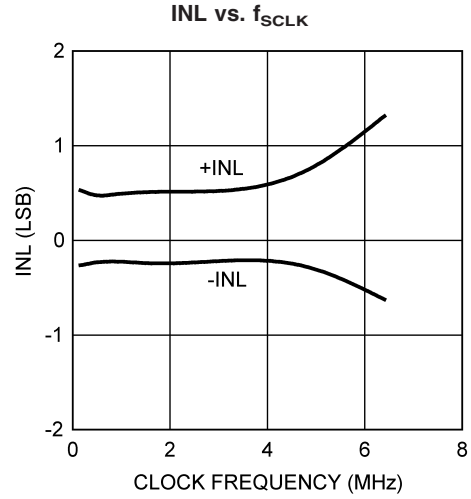
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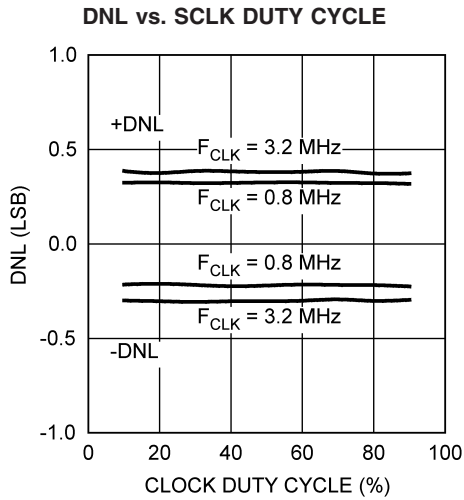
**Typical Performance Characteristics**  $T_A = +25^\circ\text{C}$ ,  $f_{\text{SAMPLE}} = 200 \text{ kpsps}$ ,  $f_{\text{SCLK}} = 3.2 \text{ MHz}$ ,  $f_{\text{IN}} = 20 \text{ kHz}$   
 unless otherwise stated. (Continued)



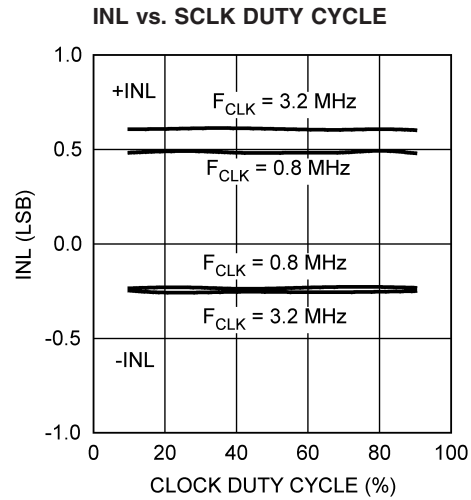
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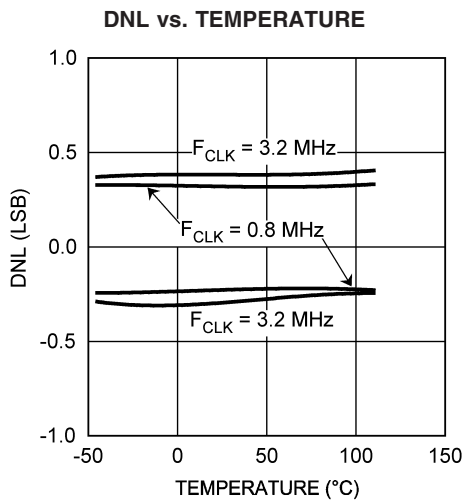
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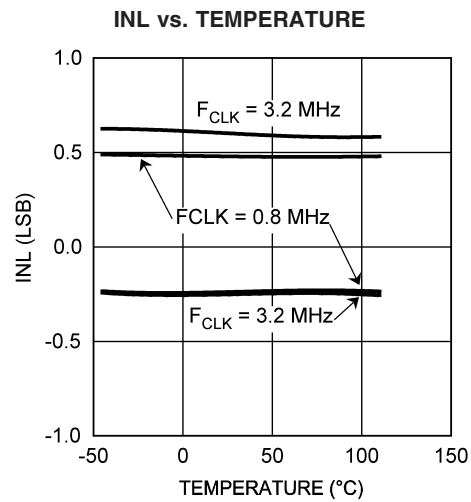
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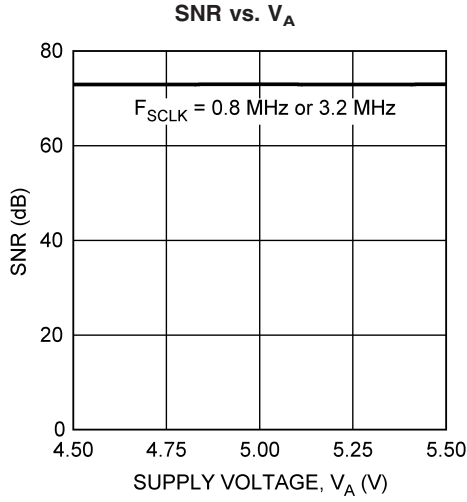


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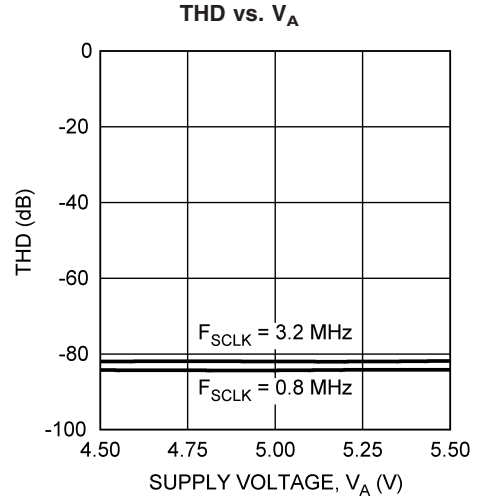


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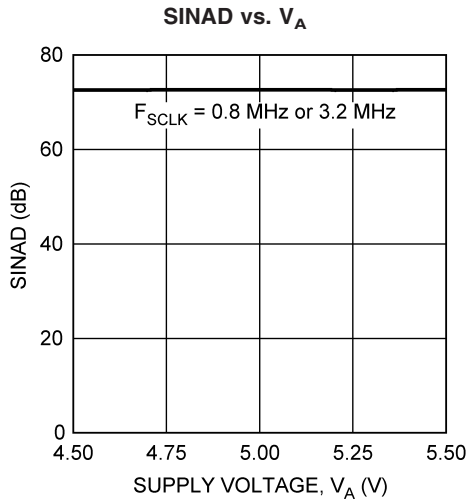
**Typical Performance Characteristics**  $T_A = +25^\circ\text{C}$ ,  $f_{\text{SAMPLE}} = 200 \text{ kpsps}$ ,  $f_{\text{SCLK}} = 3.2 \text{ MHz}$ ,  $f_{\text{IN}} = 20 \text{ kHz}$   
 unless otherwise stated. (Continued)



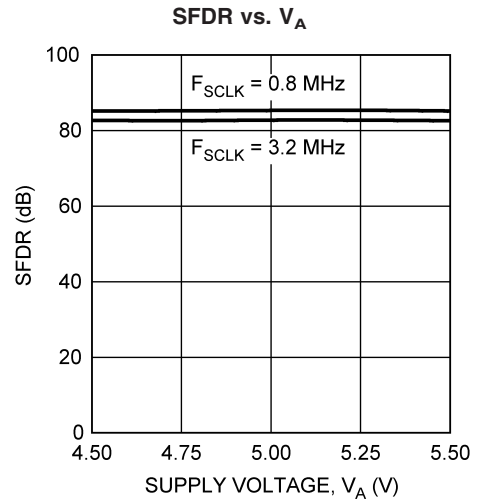
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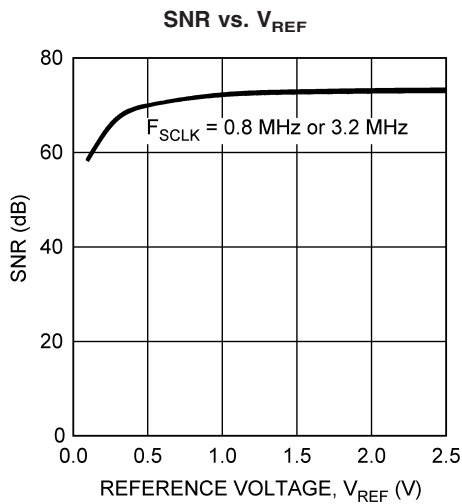
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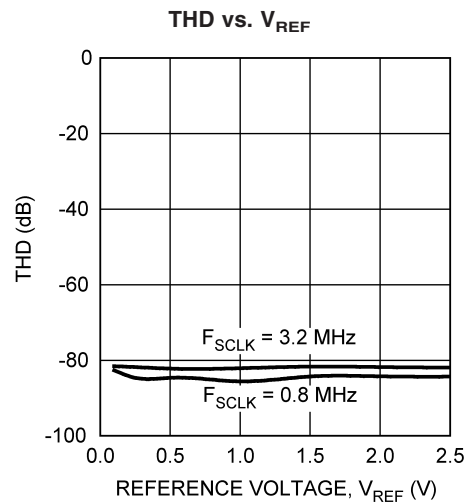
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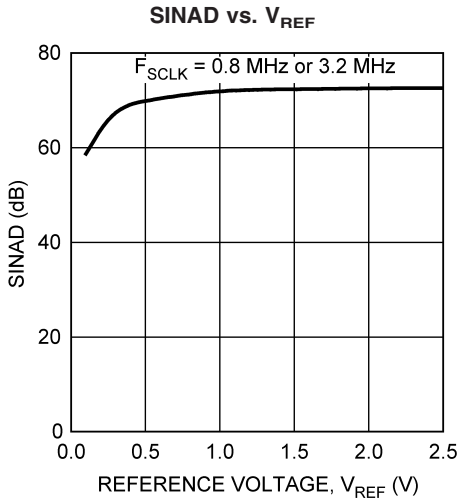


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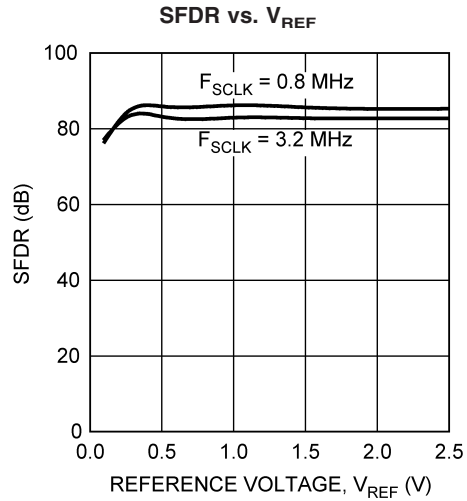


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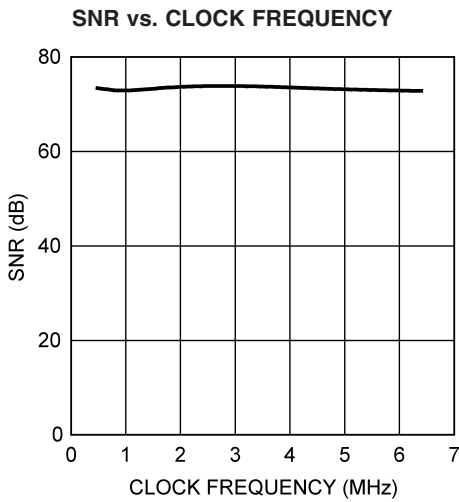
**Typical Performance Characteristics**  $T_A = +25^\circ\text{C}$ ,  $f_{\text{SAMPLE}} = 200 \text{ kpsps}$ ,  $f_{\text{SCLK}} = 3.2 \text{ MHz}$ ,  $f_{\text{IN}} = 20 \text{ kHz}$   
 unless otherwise stated. (Continued)



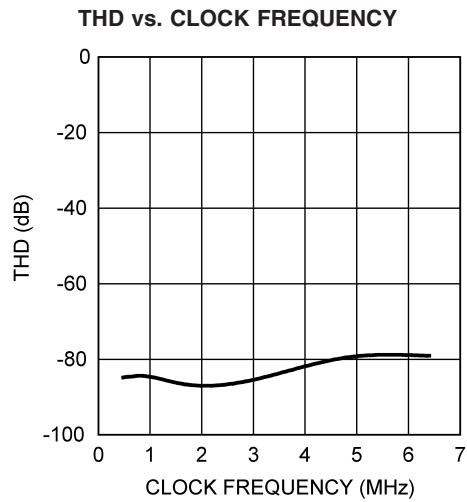
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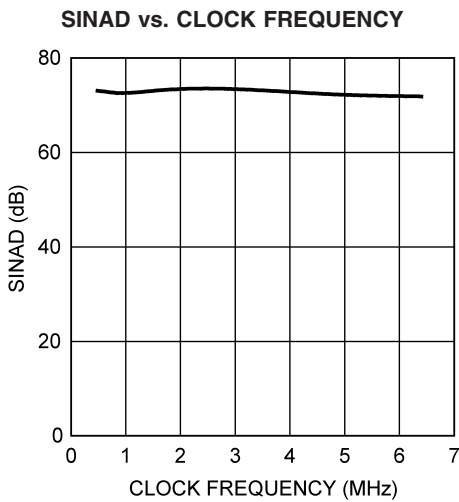
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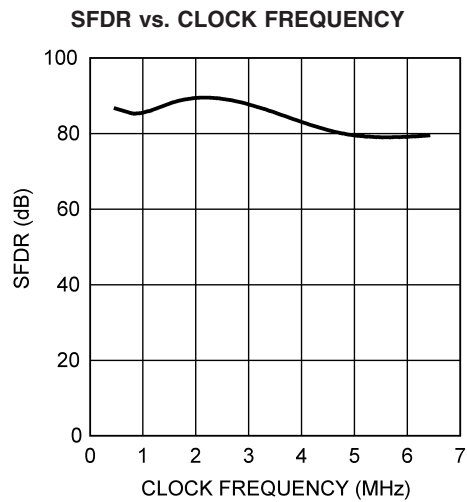
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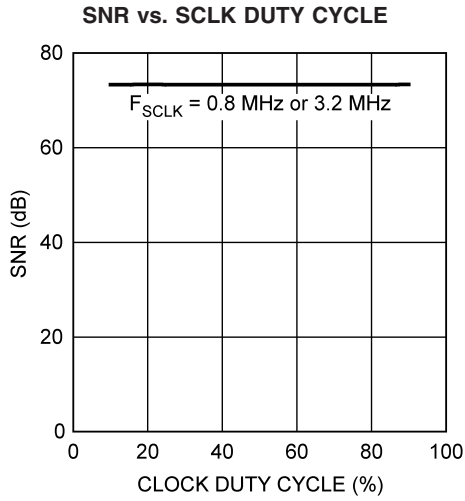


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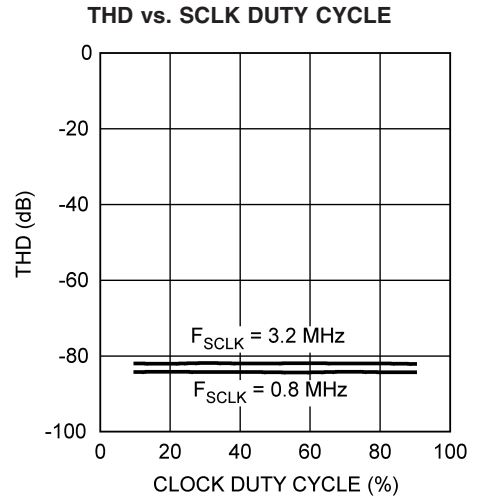


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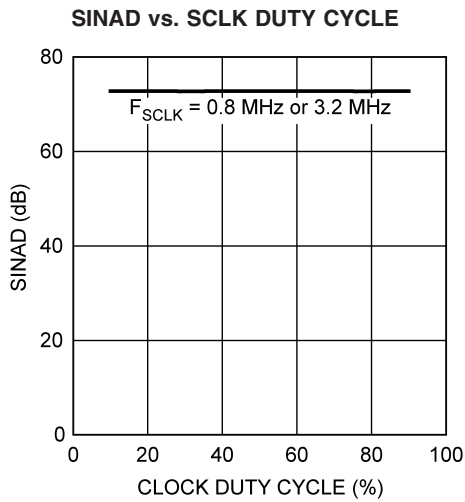
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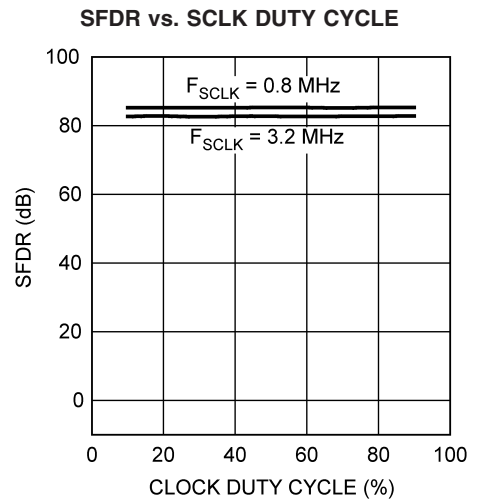
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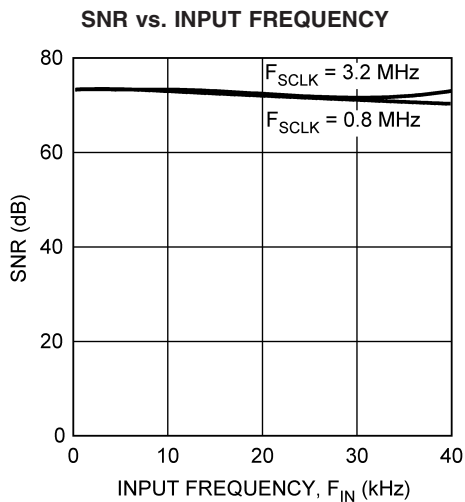
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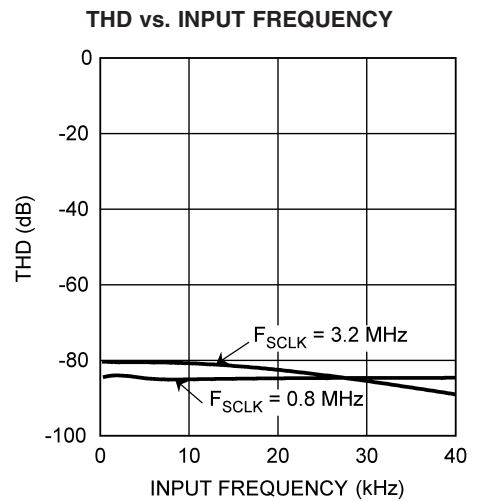
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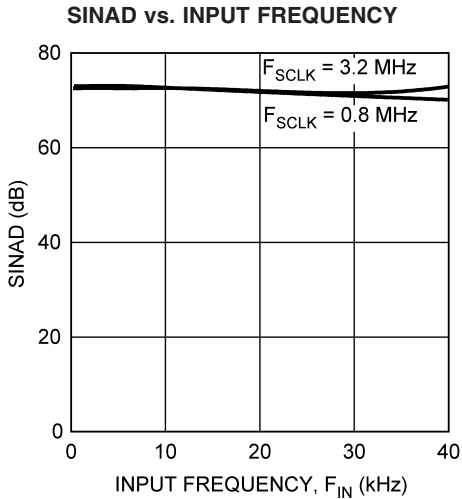


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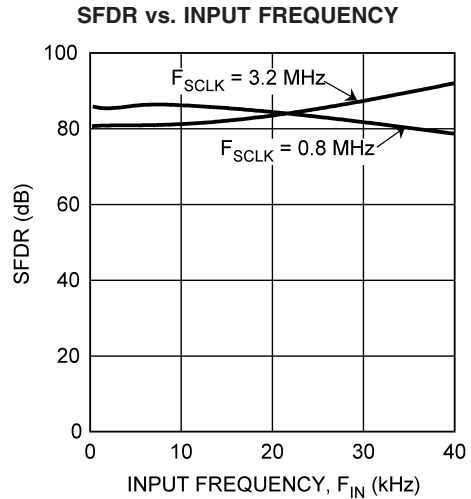


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**Typical Performance Characteristics**  $T_A = +25^\circ\text{C}$ ,  $f_{\text{SAMPLE}} = 200 \text{ kSPS}$ ,  $f_{\text{SCLK}} = 3.2 \text{ MHz}$ ,  $f_{\text{IN}} = 20 \text{ kHz}$   
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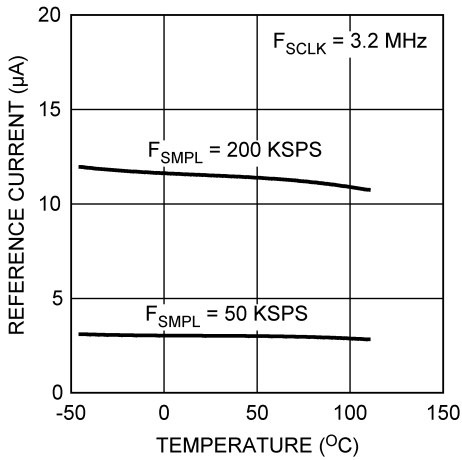


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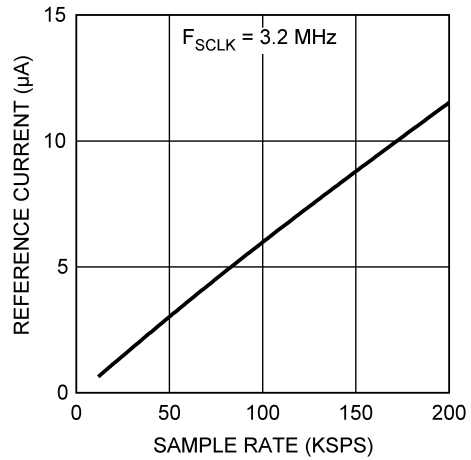
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**REF. CURRENT vs. TEMPERATURE (Output = FF8h)**



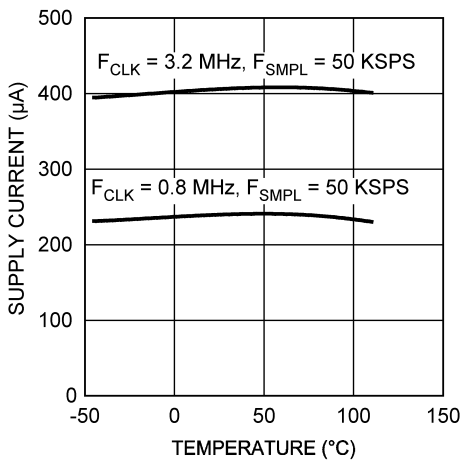
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**REF. CURRENT vs. SAMPLE RATE (Output = FF8h)**



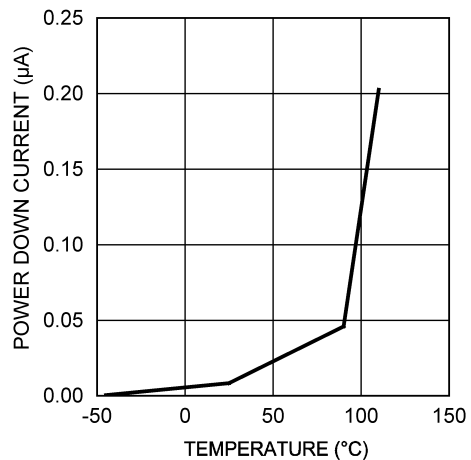
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**SUPPLY CURRENT vs. TEMPERATURE**



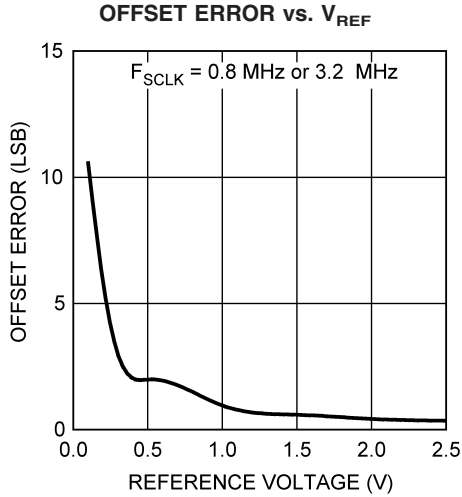
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**POWER DOWN CURRENT vs. TEMPERATURE**

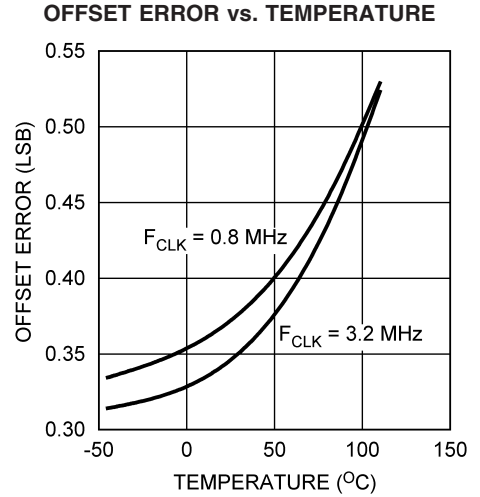


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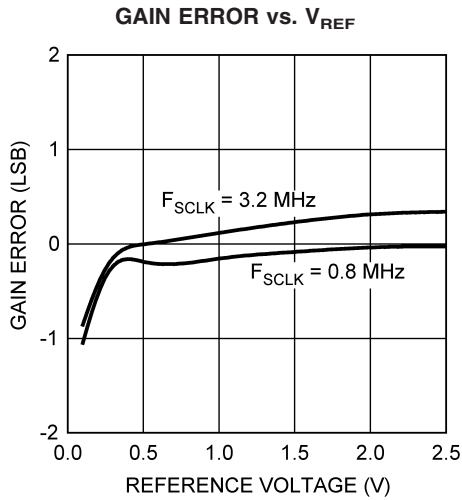
**Typical Performance Characteristics**  $T_A = +25^\circ\text{C}$ ,  $f_{\text{SAMPLE}} = 200 \text{ kpsps}$ ,  $f_{\text{SCLK}} = 3.2 \text{ MHz}$ ,  $f_{\text{IN}} = 20 \text{ kHz}$   
 unless otherwise stated. (Continued)



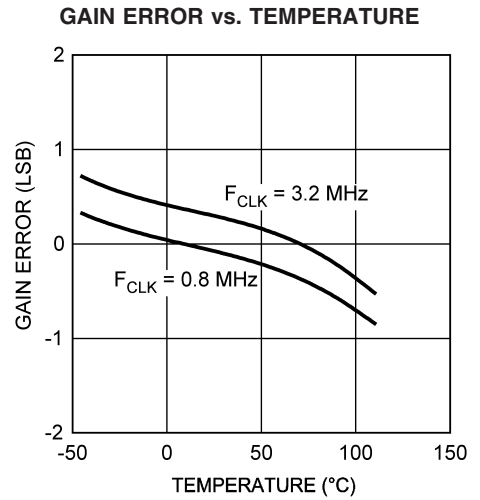
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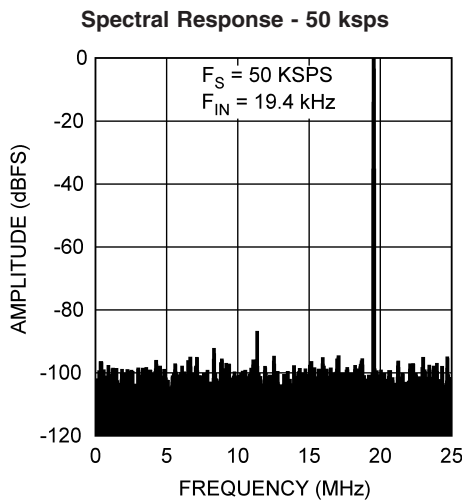
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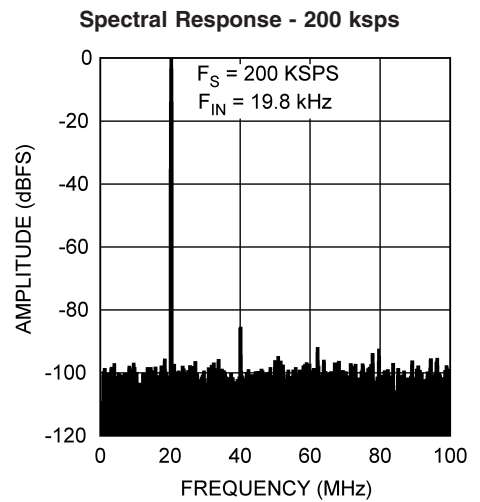
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## Functional Description

The ADC121S625 analog-to-digital converter uses a successive approximation register (SAR) architecture based upon capacitive redistribution containing an inherent sample/hold function. The architecture and process allow the ADC121S625 to acquire and convert an analog signal at sample rates up to 200,000 conversions per second while consuming very little power.

The ADC121S625 requires an external reference and external clock, and a single +5V power source that can be as low as +4.5V. The external reference can be any voltage between 100mV and 2.5V. The value of the reference voltage determines the range of the analog input, while the reference input current depends on the conversion rate.

The external clock can take on values as indicated in the Electrical Characteristics Table of this data sheet. The duty cycle of the clock is essentially unimportant, provided the minimum clock high and low times are met. The minimum clock frequency is set by internal capacitor leakage. Each conversion requires 16 SCLK cycles to complete. Short cycling can reduce this to 14 or 15 SCLK cycles, depending upon whether the clock edge after the fall of  $\overline{CS}$  is a rise or a fall. See the timing diagrams.

The analog input is presented to the two input pins: +IN and -IN. Upon initiation of a conversion, the differential input at these pins is sampled on the internal capacitor array. The inputs are disconnected from internal circuitry while a conversion is in progress.

The digital conversion result is clocked out by the SCLK input and is provided serially, most significant bit first, at the  $D_{OUT}$  pin. The digital data that is provided at the  $D_{OUT}$  pin is that of the conversion currently in progress. It is possible to continue to clock the ADC121S625 after the conversion is complete and to obtain the serial data least significant bit first. Each bit of the data word (including the leading null bit) is clocked out on subsequent falling edges of SCLK and can be clocked into the receiving device on the rising edges. See the Digital Interface section and timing diagram for more information.

### 1.0 REFERENCE INPUT

The externally supplied reference voltage sets the analog input range. The ADC121S625 will operate with a reference voltage in the range of 100mV to 2.5V. However, care must be exercised when the reference voltage is less than 500 millivolts.

As the reference voltage is reduced, the range of input voltages corresponding to each digital output code is reduced. That is, a smaller analog input range corresponds to one LSB (Least Significant Bit). The size of one LSB is equal to twice the reference voltage divided by 4096. When the LSB size goes below the noise floor of the ADC121S625, the noise will span an increasing number of codes and overall noise performance will suffer. That is, for dynamic signals the SNR will degrade and for d.c. measurements the code uncertainty will increase. Since the noise is Gaussian in nature, the effects of this noise can be reduced by averaging the results of a number of consecutive conversions.

Additionally, since offset and gain errors are specified in LSB, any offset and/or gain errors inherent in the A/D converter will increase in terms of LSB size as the reference voltage is reduced.

The ADC121S625 is more sensitive to nearby signals and EMI (electromagnetic interference) when a low reference

voltage is used. For this reason, extra care should be exercised in planning a clean layout, a low noise reference and a clean power supply when using low reference voltages.

The reference input and the analog inputs are connected to the capacitor array through a switch matrix when the input is sampled. Hence, the only current required at the reference and at the analog inputs is only a series of transient spikes. The amount of these current spikes will depend, to some degree, upon the conversion code, but will not vary a great deal.

The current required to recharge the input capacitance at the reference and analog signal inputs will cause voltage spikes at these pins. Do not try to filter out these noise spikes. Rather, ensure that the transient settles out during the sample period (1.5 clock cycles after the fall at the  $\overline{CS}$  input).

Lower reference voltages will decrease the current pulses at the reference input and, therefore, will slightly decrease the average input current there because the internal capacitance is required to take on a lower charge at lower reference voltages. The reference current changes only slightly with temperature. See the curves, "Reference Current vs. Sample Rate", "Reference Current vs. Temperature" and "SNR vs.  $V_{REF}$ " in the Typical Performance Curves section.

## 2.0 ANALOG SIGNAL INPUTS

The ADC121S625 has a differential input. As such, the effective input voltage that is digitized is (+IN) - (-IN). As is the case with any differential input A/D converter, operation with a fully differential input signal or voltage will provide better performance than with a single-ended input. Yet, the ADC121S625 can be presented with a single-ended input.

### 2.1 Differential Input Operation

With a fully differential input voltage or signal, a positive full scale output code (0111 1111 1111b or 7FFh) will be obtained when  $(+IN) - (-IN) \geq V_{REF} - 1.5 \text{ LSB}$  and a negative full scale code (1000 0000 0000b or 800h) will be obtained when  $(+IN) - (-IN) \leq -V_{REF} + 0.5 \text{ LSB}$ . This ignores gain, offset and linearity errors, which will affect the exact differential input voltage that will determine any given output code.

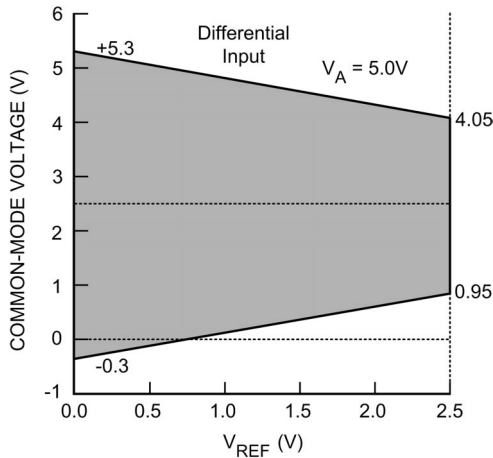
### 2.2 Single-Ended Input Operation

For single-ended operation, the non-inverting input (+IN) of the ADC121S625 should be driven with a signal or voltages that have a maximum to minimum value range that is equal to or less than twice the reference voltage. The inverting input (-IN) should be biased to a stable voltage that is half way between these maximum and minimum values. Note that single-ended operation should only be used if the performance degradation (compared with differential operation) is acceptable.

### 2.3 Input Common Mode Voltage

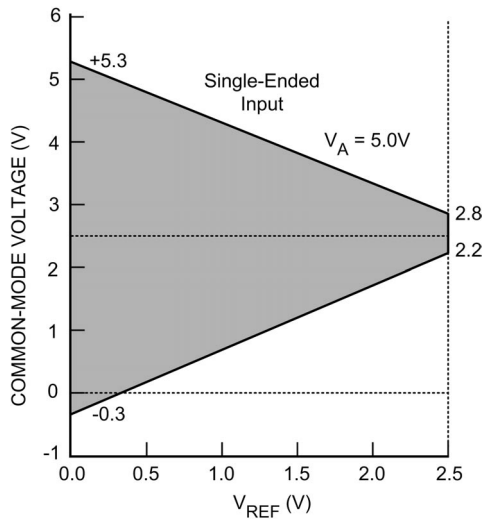
The allowable input common mode voltage ( $V_{CM}$ ) range depends upon the supply and reference voltages used for the ADC121S625 and are depicted in *Figure 1* and *Figure 2*. The minimum and maximum common mode voltages for differential and single-ended operation are shown in *Table 1*.

## Functional Description (Continued)



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FIGURE 1.  $V_{CM}$  range for Differential Input operation



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FIGURE 2.  $V_{CM}$  range for single-ended operation

TABLE 1. Allowable  $V_{CM}$  Range

| Input Signal | Minimum $V_{CM}$     | Maximum $V_{CM}$                  |
|--------------|----------------------|-----------------------------------|
| Differential | $V_{REF} / 2 - 0.3V$ | $V_A + 0.3V$<br>$- (V_{REF} / 2)$ |
| Single-Ended | $V_{REF} - 0.3V$     | $V_A + 0.3V$<br>$- V_{REF}$       |

### 3.0 SERIAL DIGITAL INTERFACE

The ADC121S625 communicates via a synchronous 3-wire serial interface as shown in the timing diagram. Each output bit is sent on the falling edge of SCLK. While most receiving systems will capture the digital output bits on the rising edge of SCLK, the falling edge of SCLK may be used to capture each bit if the minimum hold time for  $D_{OUT}$  is acceptable.

### 3.1 Digital Inputs

The Digital inputs consist of the SCLK and  $\overline{CS}$ . A falling  $\overline{CS}$  initiates the conversion and data transfer. The time between the fall of  $\overline{CS}$  and the second falling edge of SCLK is used to sample the input signal. The data output is enabled at the second falling edge of SCLK that follows the fall of  $\overline{CS}$ . Since the first bit clocked out is a null bit, the MSB is clocked out on the third falling edge of SCLK after the fall of  $\overline{CS}$ . For the next 12 SCLK periods  $D_{OUT}$  will output the conversion result, most significant bit first. After the least significant bit (B0) has been output, the output data is repeated if  $\overline{CS}$  remains low after the LSB is output, but in a least significant bit first format, with the LSB being output only once, as indicated in the Double Cycle Timing Diagram.  $D_{OUT}$  will go into its high impedance state after the B9 - B10 - B11 sequence. If  $\overline{CS}$  is raised between prior to or at the 15th clock fall,  $D_{OUT}$  will go into its high impedance state after the LSB (B0) is output and the data is not repeated. Additional clock cycles will not effect the converter. A new conversion is initiated only when  $\overline{CS}$  has been taken HIGH and returned LOW.

### 3.1 SCLK Input

The SCLK (serial clock) is used to time the conversion process and to clock out the conversion results. This input is TTL/CMOS compatible. Internal settling time limits the maximum clock frequency and internal capacitor leakage, or droop, limits the minimum clock frequency. The ADC121S625 offers guaranteed performance with clock rates in the range indicated in the electrical table.

### 3.2 Data Output

The output data format of the ADC121S625 is Two's Complement, as shown in Table 2. This table indicates the ideal output code for the given input voltage and does not include the effects of offset, gain error, linearity errors, or noise.

TABLE 2. Ideal Output Code vs. Input Voltage

| Description      | Analog Input (+IN) - (-IN) | 2's Complement Binary Output | 2's Comp. Hex Code |
|------------------|----------------------------|------------------------------|--------------------|
| + Full Scale     | $V_{REF} - 1 \text{ LSB}$  | 0111 1111 1111               | 7FF                |
| Midscale         | 0V                         | 0000 0000 0000               | 000                |
| Midscale - 1 LSB | $0V - 1 \text{ LSB}$       | 1111 1111 1111               | FFF                |
| - Full Scale     | $-V_{REF}$                 | 1000 0000 0000               | 800                |

## Applications Information

### OPERATING CONDITIONS

We recommend that the following conditions be observed for operation of the ADC121S625:

$$-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$$

$$+4.5V \leq V_A \leq +5.5V$$

$$0.1V \leq V_{REF} \leq 2.5V$$

$$0.8 \text{ MHz} \leq f_{CLK} \leq 4.8 \text{ MHz}$$

$V_{CM}$ : See Section 2.3



## Applications Information (Continued)

### 4.0 POWER CONSUMPTION

The architecture, design and fabrication process allows the ADC121S625 to operate at conversion rates up to 200ksps while requiring very little power. In order to minimize power consumption in applications requiring sample rates below 50ksps, the ADC121S625 should be run at a  $f_{SCLK}$  of 3.2 MHz and with the  $\overline{CS}$  rate as slow as the system requires. The ADC will go into the power down mode at the end of each conversion, minimizing power consumption. See Section 4.2 for more information.

However, some things should be kept in mind to absolutely minimize power consumption.

The consumption scales directly with conversion rate, so minimizing power consumption requires determining the lowest conversion rate that will satisfy the requirements of the system.

The ADC121S625 goes into its power down mode on the rising edge of  $\overline{CS}$  or the 14th or 16th falling edge of SCLK after the fall of  $\overline{CS}$ , as described in the Functional Description, whichever occurs first (see Timing Diagrams). Ideally, each conversion should occur as quickly as possible, preferably at the maximum rated clock rate and the  $\overline{CS}$  rate used to determine the sample rate. This causes the converter to spend the longest possible time in the power down mode. This is very important for minimizing power consumption as the converter uses current for the analog circuitry, which continuously consumes power when converting. So, if less than 12 bits are needed, power may be saved by bringing  $\overline{CS}$  high after clocking out the number of bits needed.

Of course, the converter also uses power on each SCLK transition, as is typical for digital CMOS components, so stopping the clock when in the power down mode will further reduce power consumption. As mentioned in the Reference Input Section 1.0, power consumption is also slightly lower with lower reference voltages.

There is an important difference between entering the power down mode after a conversion is complete and  $\overline{CS}$  if left LOW and the full power down mode when  $\overline{CS}$  is HIGH. Both of these power down the analog portion of the ADC121S625, but the digital portion is powered down only when  $\overline{CS}$  is HIGH. So, if  $\overline{CS}$  is left LOW at the end of a conversion and the converter is continually clocked, the power consumption will not be as low as when  $\overline{CS}$  is HIGH.

#### 4.1 Short Cycling

Another way of saving power is to short cycle the conversion process. This is done by pulling the  $\overline{CS}$  line high after the last required bit is received from the ADC121S625 output. This is possible because the ADC121S625 places the latest data bit on the  $D_{OUT}$  line as it is generated. If only 8-bits of the conversion result are needed, for example, the conversion can be terminated by pulling  $\overline{CS}$  HIGH after the 8th bit has been clocked out. Halting conversion after the last needed bit is received is called short cycling.

Short cycling can be used to lower the power consumption in those applications that do not need a full 12-bit resolution, or where an analog signal is being monitored until some condition occurs. For example, it may not be necessary to use the full 12-bit resolution of the ADC121S625 as long as the signal being monitored is within certain limits. The conversion, then, can be terminated after the first few bits (as low as 3 or 4 bits, in some cases). This can lower power con-

sumption in both the converter and the rest of the system, because they spend more time in the power down mode and less time in the active mode.

Short cycling can also be used to reduce the required number of SCLK cycles from 16 to 14, allowing for a little faster throughput. That is, SCLK can be raised after the rise of the 14th SCLK, reducing the overall cycle time ( $t_{CYC}$ ) by about 12%.

#### 4.2 Burst Mode Operation

Normal operation requires the SCLK frequency to be 16 times the sample rate and the  $\overline{CS}$  rate to be the same as the sample rate. However, because starting a new conversion requires a new fall of  $\overline{CS}$ , it is possible to have the SCLK rate much higher than 16 times the  $\overline{CS}$  rate. When this is done, the device is said to be operating in the Burst Mode.

Burst Mode operation has the advantage of lowering overall power consumption because the device goes into power down when conversion is complete and only the output register and output drivers remain powered up to clock out the data. This circuit also powers down and the output drivers go into their high impedance state once the last bit is clocked out.

Note that the output register and output drivers will remain powered up longer if  $\overline{CS}$  is not brought high before the 15th fall of SCLK after the fall of  $\overline{CS}$ . See the Double Cycle Timing Diagram.

### 5.0 TIMING CONSIDERATIONS

Proper operation requires that the fall of  $\overline{CS}$  occur between the fall and rise of SCLK. If the fall of  $\overline{CS}$  occurs while SCLK is high, the data might be clocked out one bit early. Whether or not the data is clocked out early depends upon how close the  $\overline{CS}$  transition is to the SCLK transition, the device temperature, and characteristics of the individual device. To ensure that the data is always clocked out at a time, it is essential that the fall of  $\overline{CS}$  always occurs while SCLK is low.

### 6.0 PCB LAYOUT AND CIRCUIT CONSIDERATIONS

Care should be taken with the physical layout of the printed circuit board so that best performance may be realized. This is especially true with a low reference voltage or when the conversion rate is high. At high clock rates there is less time for settling, so it is important that any noise settles out much faster if accuracy is to be maintained.

Any SAR architecture is sensitive to spikes on the power supply, reference, and ground connections that occur just prior to latching the comparator output. Spikes might originate, for example, from switching power supplies, digital logic, and high power devices, and other sources. This type of problem can be very difficult to track down if the glitch is almost synchronous to the converter's SCLK, but the phase difference between SCLK and the noise source may change with time and temperature, causing sporadic problems. Power to the ADC121S625 should be clean and well bypassed. A 0.1 $\mu$ F ceramic bypass capacitor and a 1 $\mu$ F to 10 $\mu$ F capacitor should be used to bypass the ADC121S625 supply, with the 0.1 $\mu$ F capacitor placed as close to the ADC121S625 package as possible. Adding a 10 $\Omega$  resistor in series with the power supply line will help to low pass filter a noisy supply.

The reference input should be bypassed with a minimum 0.1 $\mu$ F capacitor. A series resistor and large capacitor can be used to low pass filter the reference voltage. If the reference voltage originates from an op-amp, be careful that the op-amp can drive the bypass capacitor without oscillation (the

## Applications Information (Continued)

series resistor can help in this case). Keep in mind that while the AD121S625 draws very little current from the reference on average, there are higher instantaneous current spikes at the reference input that must settle out while SCLK is HIGH. Because these transient spikes can be almost as high as 20mA, it is important that the reference circuit be capable of providing this much current and settle out during the minimum 1.5 clock sampling period. Be sure to observe the minimum SCLK HIGH and LOW times.

The reference input of the ADC121S625, like all A/D converters, does not reject noise or voltage variations. Keep this in mind if the reference voltage is derived from the power supply. Any noise and/or ripple from the supply that is not rejected by the external reference circuitry will appear in the digital results. While high frequency noise can be filtered out as described above, voltage variation due to supply ripple (50Hz to 120Hz) can be difficult to remove. The use of an active reference source can ease this problem. The LM4040 and LM4050 shunt reference families and the LM4120, LM4121 and LM4140 low dropout series reference families offer a range of choices for a reference source.

The GND pin on the ADC121S625 should be connected to the ground plane at a quiet point. While there are many opinions as to the best way to use power and ground planes, we have looked into this in great detail and have concluded that all methods can work well up to speeds of about 30MHz to 40MHz if there is strict adherence to the individual method. However, many of these methods lead to excessive EMI/RFI, which is not acceptable from a system standpoint. Generally, good layout and interconnect techniques can provide the excellent performance required while minimizing EMI/RFI, often without the need for shielding.

We recommend a single ground plane and the use of two or more power planes. The power planes should all be in the same board layer and will define, for example, the analog board area, general digital board area and high power digital board area. Lines associated with these areas should always be routed within their respective areas. There are rules for those cases where a line must cross to another area, but that is beyond the scope of this document.

Avoid connecting the GND pin too close to the ground point for a microprocessor, microcontroller, digital signal processor, or other high power digital device.

### 7.0 APPLICATION CIRCUITS

The following figures are examples of ADC121S625 typical application circuits. These circuits are basic ones and will generally require modification for specific circumstances.

### 7.1 Data Acquisition

Figure 3 shows a basic low cost, low power data acquisition circuit. Maximum clock rate with a minimum sample rate can reduce the power consumption further.

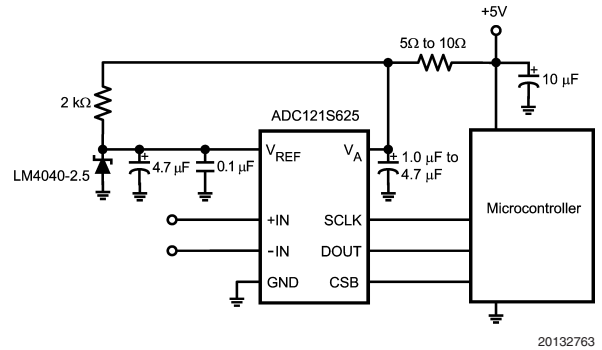


FIGURE 3. Low cost, low power Data Acquisition System

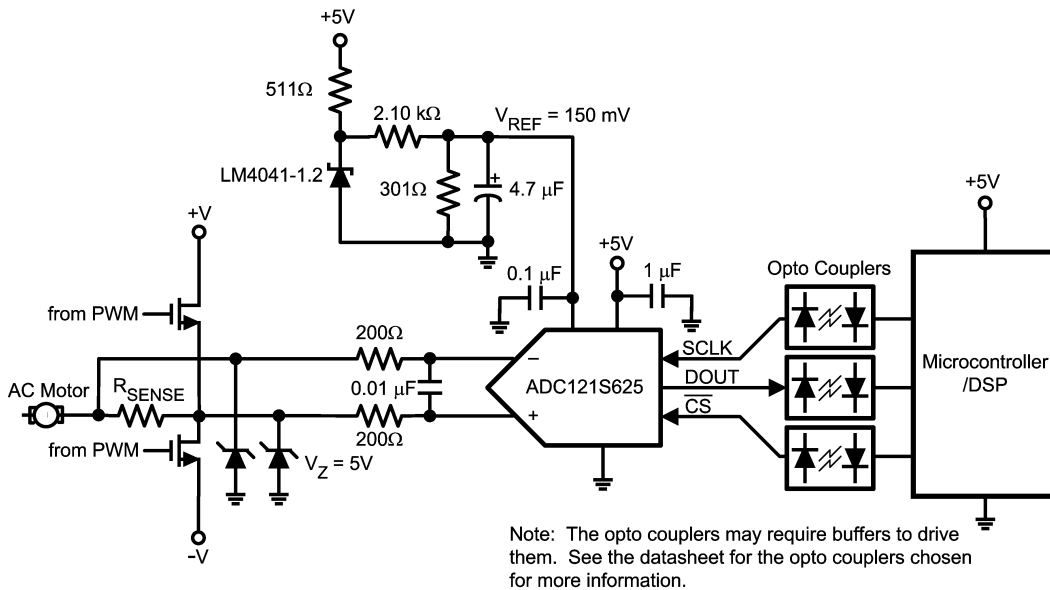
### 7.2 Motor Control

Figure 4 is a motor control application that isolates the digital outputs of the AD121S625 instead of isolating the analog signal from the motor. As shown here, the reference voltage for the AD121S625 is 150mV, and the analog input of the AD121S625 is connected directly to the current sense resistor. Keeping isolation amplifiers out of the signal path enables a greater system signal-to-noise ratio. However, three optical isolators are needed to isolate the A/D converters rather than an isolation amplifier. For three-phase motors, three of these circuits are needed.

### 7.3 Strain Gauge Interface

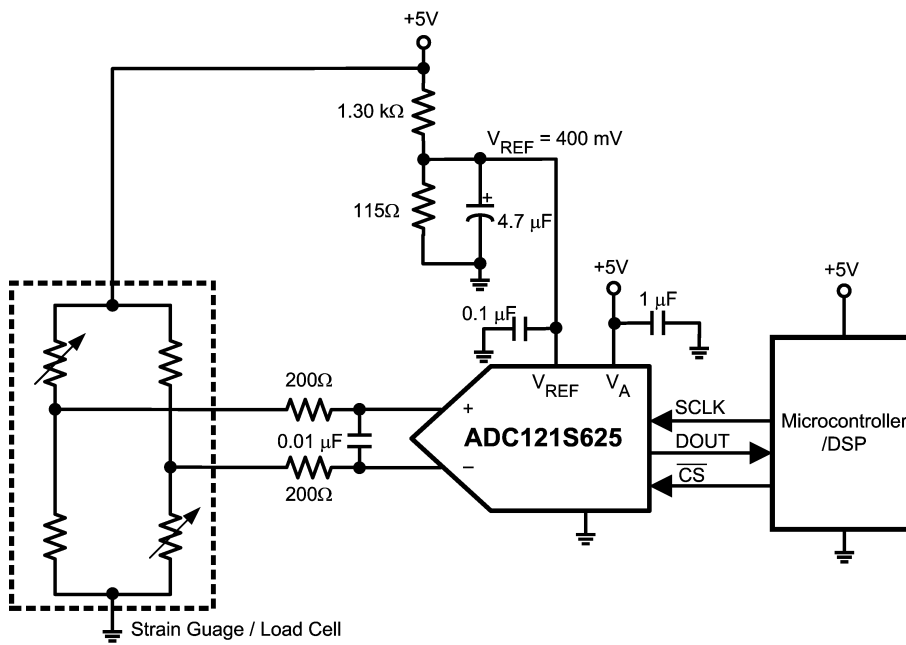
Figure 5 shows an example of interfacing a strain gauge or load cell to the AD121S625. The same voltage used to bias the strain gauge is used as a source for the reference voltage, providing ratiometric operation and making the system immune to variations in the source voltage. Of course, there is no immunity to noise on the reference source or on the strain gauge source. The value of the divider resistors to provide the reference voltage for the ADC121S625 may need to be changed to provide the desired reference voltage for the specific application.

Applications Information (Continued)



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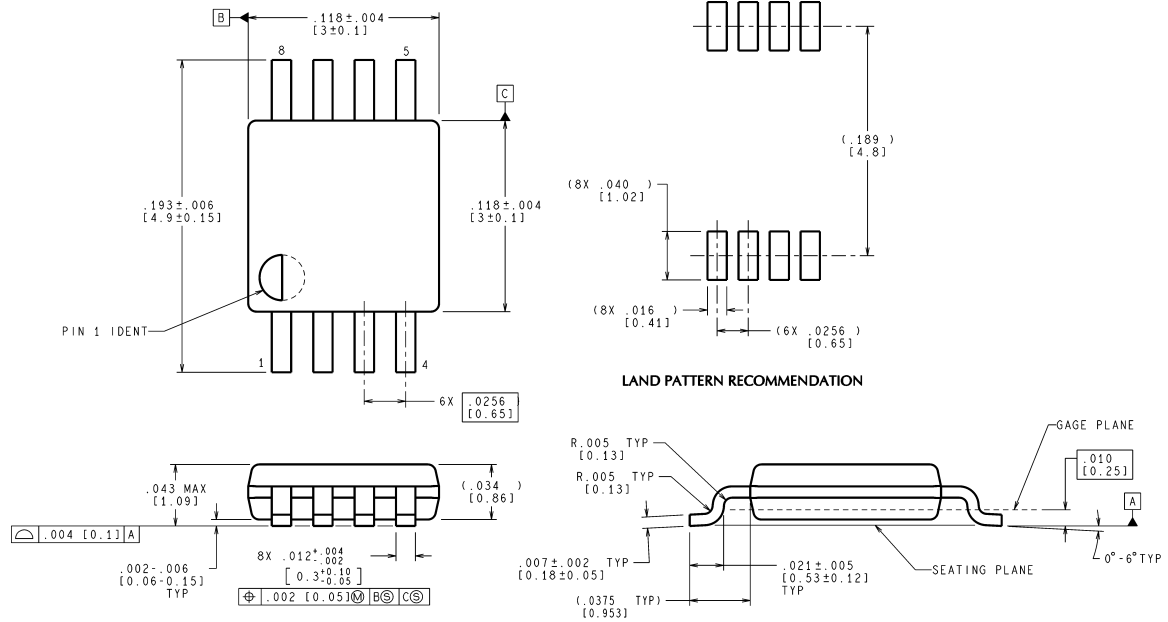
FIGURE 4. Motor Control using isolated ADC121S625



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FIGURE 5. Interfacing the ADC121S625 to a strain gauge

**Physical Dimensions** inches (millimeters) unless otherwise noted



CONTROLLING DIMENSION IS INCH  
VALUES IN [ ] ARE MILLIMETERS

MUA08A (Rev E)

**8-Lead MSOP**  
**Order Number ADC121S625CIMM**  
**NS Package Number MUA08A**

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